

Title (en)

CONDUCTOR CONNECTION, CONNECTION PIECE AND METHOD FOR PRODUCING A CONDUCTOR CONNECTION

Title (de)

LEITERVERBINDUNG, VERBINDUNGSSTÜCK UND VERFAHREN ZUR HERSTELLUNG EINER LEITERVERBINDUNG

Title (fr)

RACCORDEMENT DE CONDUCTEURS, PIÈCE DE CONNEXION ET PROCÉDÉ DE PRODUCTION D'UN RACCORDEMENT DE CONDUCTEURS

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Application

EP 17825771 A 20171211

Priority

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- EP 2017082231 W 20171211

Abstract (en)

[origin: WO2018114433A1] The invention relates to a conductor connection (100) comprising a connection part (1) and several electric conductors (2, 3). The connecting part (1) has two or more openings (7, 8). The conductors (2, 3) extend respectively through one of the openings (7, 8) into the connection part (1). The connection part (1) comprises a wall (11), the distance (a) thereof from a longitudinal axis (6) of the connection part (1) increasing to at least one of the openings (7, 8). The connection part (1) is designed in particular as a curved strip part (18) with overlapping lateral regions (14, 15).

IPC 8 full level

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CPC (source: EP US)

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Citation (search report)

See references of WO 2018114433A1

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